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STN	**Tavivá na mäkké spájkovanie Skúšobné metódy Časť 14: Stanovenie priľnavosti zvyškov taviva (ISO 9455-14: 2017)**	**STN EN ISO 9455-14 05 5707**

Soft soldering fluxes - Test methods - Part 14: Assessment of tackiness of flux residues (ISO 9455-14:2017)

Táto norma obsahuje anglickú verziu európskej normy.
This standard includes the English version of the European Standard.

Táto norma bola oznámená vo Vestníku ÚNMS SR č. 03/18

Obsahuje: EN ISO 9455-14:2017, ISO 9455-14:2017

Oznámením tejto normy sa ruší
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EUROPEAN STANDARD

NORME EUROPÉENNE

EUROPÄISCHE NORM

EN ISO 9455-14

September 2017

ICS 25.160.50 Supersedes EN 29455-14:1993

English Version

Soft soldering fluxes - Test methods - Part 14: Assessment of tackiness of flux residues (ISO 9455-14:2017)

Flux de brasage tendre - Méthodes d'essai - Partie 14: Détermination du pouvoir collant des résidus de flux (ISO 9455-14:2017)

Flußmittel zum Weichlöten - Prüfverfahren; Teil 14: Bestimmung des Haftvermögens von Flußmittelrückständen (ISO 9455-14:2017)

This European Standard was approved by CEN on 12 September 2017.

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European foreword

This document (EN ISO 9455-14:2017) has been prepared by Technical Committee ISO/TC 44 “Welding and allied processes” in collaboration with Technical Committee CEN/TC 121 “Welding and allied processes” the secretariat of which is held by DIN.

This European Standard shall be given the status of a national standard, either by publication of an identical text or by endorsement, at the latest by March 2018, and conflicting national standards shall be withdrawn at the latest by March 2018.

Attention is drawn to the possibility that some of the elements of this document may be the subject of patent rights. CEN shall not be held responsible for identifying any or all such patent rights.

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Endorsement notice

The text of ISO 9455-14:2017 has been approved by CEN as EN ISO 9455-14:2017 without any modification.

INTERNATIONAL STANDARD

ISO 9455-14

Second edition
2017-08

Soft soldering fluxes — Test methods —

Part 14: Assessment of tackiness of flux residues

Flux de brasage tendre — Méthodes d'essai —

Partie 14: Détermination du pouvoir collant des résidus de flux

Reference number
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Foreword

ISO (the International Organization for Standardization) is a worldwide federation of national standards bodies (ISO member bodies). The work of preparing International Standards is normally carried out through ISO technical committees. Each member body interested in a subject for which a technical committee has been established has the right to be represented on that committee. International organizations, governmental and non-governmental, in liaison with ISO, also take part in the work. ISO collaborates closely with the International Electrotechnical Commission (IEC) on all matters of electrotechnical standardization.

The procedures used to develop this document and those intended for its further maintenance are described in the ISO/IEC Directives, Part 1. In particular the different approval criteria needed for the different types of ISO documents should be noted. This document was drafted in accordance with the editorial rules of the ISO/IEC Directives, Part 2 (see www.iso.org/directives).

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Any trade name used in this document is information given for the convenience of users and does not constitute an endorsement.

For an explanation on the voluntary nature of standards, the meaning of ISO specific terms and expressions related to conformity assessment, as well as information about ISO's adherence to the World Trade Organization (WTO) principles in the Technical Barriers to Trade (TBT) see the following URL: www.iso.org/iso/foreword.html.

This document was prepared by Technical Committee ISO/TC 44, *Welding and allied processes*, Subcommittee SC 12, *Soldering materials*.

This second edition cancels and replaces the first edition (ISO 9455-14:1991), which has been technically revised.

The main changes compared to the previous edition are as follows:

— the test report has been updated;

— this document has been editorially revised.

A list of all parts in the ISO 9455 series can be found on the ISO website.

Requests for official interpretations of any aspect of this document should be directed to the Secretariat of ISO/TC 44/SC 12 via your national standards body. A complete listing of these bodies can be found at www.iso.org.

INTERNATIONAL STANDARD **ISO 9455-14:2017(E)**

Soft soldering fluxes — Test methods —

Part 14: Assessment of tackiness of flux residues

1 Scope

This document specifies a qualitative method for the assessment of the tackiness of the residues of a soft soldering flux after a soldering process. The method is applicable to all fluxes, solder pastes and flux cored solder wires. The method is particularly appropriate for applications where flux residues are left *in situ* on electrical and electronic equipment.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

ISO 197-1, *Copper and copper alloys — Terms and definitions — Part 1: Materials*

ISO 9453, *Soft solder alloys — Chemical compositions and forms*

ISO 9455-1, *Soft soldering fluxes — Test methods — Part 1: Determination of non-volatile matter, gravimetric method*

ISO 9455-2, *Soft soldering fluxes — Test methods — Part 2: Determination of non-volatile matter, ebulliometric method*

